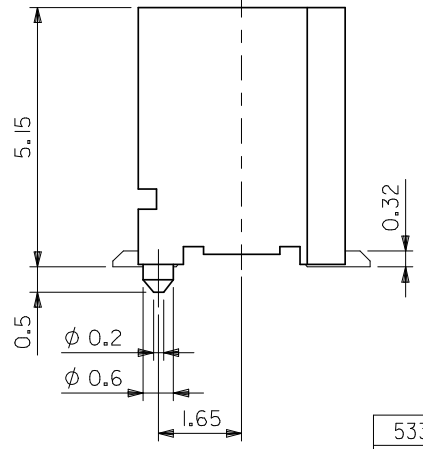


注記 NOTES

1. 嵌合相手：52465 シリーズ
MATES WITH : 52465 SERIES
2. ウェハの \odot から隣接するピンの \odot 迄の位置を示す。
SHOW POSITION FROM \odot OF WAFER TO \odot OF ADJACENT PINS.
3. 本製品は 53364-**17 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53364-**17



53364-**19
MODEL NO.

17.0	0.4	17.8	16.9	15.2	53364-4019	40
15.4	0.4	16.2	15.3	13.6	53364-3619	36
13.0	0.8	13.8	12.9	11.2	53364-3019	30
12.2	0.4	13.0	12.1	10.4	53364-2819	28
9.0	0.4	9.8	8.9	7.2	53364-2019	20
8.2	0.8	9.0	8.1	6.4	53364-1819	18
5.8	0.4	6.6	5.7	4.0	53364-1219	12
5.0	0.8	5.8	4.9	3.2	53364-1019	10
	E	D	C	B	A	MATERIAL NO. 極数 CKT.

REVISED EC NO: J2008-3931 DRWN: MAKURAA 2008/05/26 CHKD: T. HARIYAMA 2008/05/26 APPR: NUKITA 2008/08/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		10 UNDER	±0.2					DRAWN BY M. NABEI	DATE	TITLE
		10 OVER 30 UNDER	±0.25					CHECKED BY K. TOJO	DATE	
		30 OVER	±0.3					APPROVED BY M. SASAO	DATE	
		ANGULAR	±3 °	MATERIAL NO.	DOCUMENT NO.					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

0.8 BOARD TO BOARD CONN.
WAFER ASS ST.SMT
-LEAD FREE-

MOLEX INCORPORATED

SEE TABLE SD-53364-001